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Part Number: [87832-2223](#)
Status: **Active**
Overview: [Milli-Grid™ Connector System](#)
Description: 2.00mm Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-Free, 22 Circuits, 0.76µm Gold (Au) Plating, with Locking Windows and Center Polarization Slot, PCB Locator, Tube

Documents:

[3D Model](#) [Product Specification PS-87831-027 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
 UL E29179

General

Product Family PCB Headers
 Series [87832](#)
 Application Signal, Wire-to-Board
 Comments With Cap; Contact Molex for application in automotive industry
 Overview [Milli-Grid™ Connector System](#)
 Product Name Milli-Grid™
 UPC 883906685997

Physical

Breakaway No
 Circuits (Loaded) 22
 Circuits (maximum) 22
 Color - Resin Black
 Durability (mating cycles max) 100
 First Mate / Last Break No
 Flammability 94V-0
 Glow-Wire Compliant No
 Guide to Mating Part No
 Keying to Mating Part Yes
 Lock to Mating Part Yes
 Material - Metal Phosphor Bronze
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin Nylon
 Net Weight 1.166g
 Number of Rows 2
 Orientation Vertical
 PCB Locator No
 PCB Retention None
 Packaging Type Tube
 Pitch - Mating Interface 2.00mm
 Pitch - Termination Interface 2.00mm
 Plating min - Mating 0.762µm
 Plating min - Termination 1.905µm
 Polarized to PCB No
 Robotic Placement Pick and Place Cap
 Shrouded Fully
 Stackable No
 Surface Mount Compatible (SMC) Yes



EU RoHS

ELV and RoHS Compliant

REACH SVHC

Not Reviewed

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[87832Series](#)

Mates With

[50394](#) Wire-to-Board Terminals, [51110](#) Wire-to-Board Crimp Housing, [87568](#) Wire-to-Board IDT Housings, [79107](#) Board-to-Board Top Entry Through Hole Receptacle, [79108](#) Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, [79109](#) Board-to-Board Surface Mount PCB Receptacle

Temperature Range - Operating -55°C to +105°C
Termination Interface: Style Through Hole and Surface Mount

Electrical

Current - Maximum per Contact 2A
Voltage - Maximum 125V

Solder Process Data

Duration at Max. Process Temperature (seconds) 10
Lead-free Process Capability Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature 1
Process Temperature max. C 260

Material Info

Reference - Drawing Numbers

Product Specification PS-87831-027
Sales Drawing SD-87832-007

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